SN54LS222A 16×4 SYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY WITH 3-STATE OUTPUTS SDLS959A - DECEMBER 2001 - REVISED APRIL 2003 Independent Synchronous Inputs and J PACKAGE (TOP VIEW) Outputs 16 Words by 4 Bits Each 20 🛛 V_{CC} OE 3-State Outputs Drive Bus Lines Directly IRE II 2 19 UNCK IR 🛛 3 18 ORE Data Rates up to 10 MHz LDCK 17 🛛 OR Fall-Through Time 50 ns Typical D0 5 16 🛛 Q0 **Data Terminals Arranged for Printed Circuit** 15 **NC** NC 6 **Board Layout** D1 🛛 7 14 🛛 Q1 • Expandable, Using External Gating D2 8 13 🛛 Q2 Packaged in Standard Ceramic (J) 300-mil D3 🛛 9 12 🛛 Q3 DIPs GND [10 11 CLR

description

NC - No internal connection

The SN54LS222A 64-bit, low-power Schottky memory is organized as 16 words by 4 bits each. It can be expanded in multiples of 15m + 1 words or 4n bits, or both (where n is the number of packages in the vertical array, and m is the number of packages in the horizontal array); however, some external gating is required. For longer words, the input-ready (IR) signals of the first-rank packages and output-ready (OR) signals of the last-rank packages must be ANDed for proper synchronization.

A first-in, first-out (FIFO) memory is a storage device that allows data to be written to and read from its array at independent data rates. These FIFOs are designed to process data at rates up to 10 MHz in a bit-parallel format, word by word.

The load clock (LDCK) normally is held low, and data is written into memory on the high-to-low transition of LDCK. The unload clock (UNCK) normally is held high, and data is read out on the low-to-high transition of UNCK. The memory is full when the number of words clocked in exceeds by 16 the number of words clocked out. When the memory is full, LDCK signals have no effect on the data residing in memory. When the memory is empty, UNCK signals have no effect.

Status of the FIFO memory is monitored by the IR and OR flags that indicate not-full and not-empty conditions. IR is high only when the memory is not full and LDCK is low. OR is high only when the memory is not empty and UNCK is high.

A low level on the clear (CLR) input resets the internal stack-control pointers and also sets IR high and OR low to indicate that old data remaining at the data outputs is invalid. Data outputs are noninverting with respect to the data inputs and are at high impedance when the output-enable (OE) input is low. OE does not affect the IR and OR outputs.

The SN54LS222A is characterized over the full military temperature range of -55°C to 125°C.



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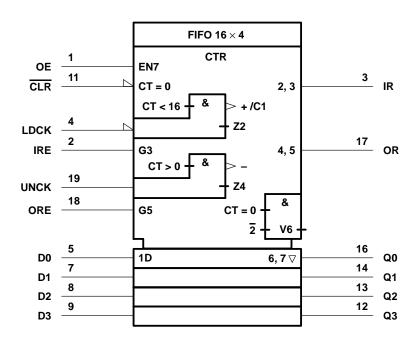


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logic symbol[†]

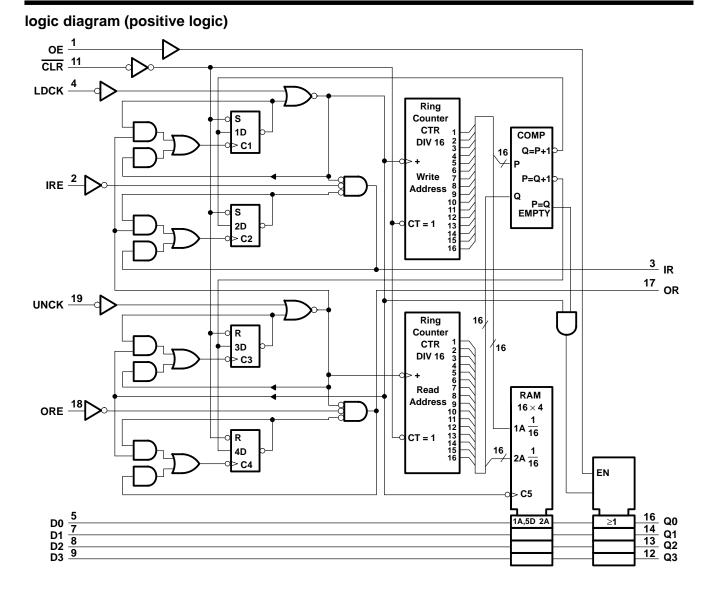


[†] This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12. This symbol is functionally accurate, but does not show the details of implementation; for these details, see the logic diagram. The symbol represents the memory as if it were controlled by a single counter whose content is the number of words stored at the time. Output data is invalid when the counter content (CT) is 0.



 $\begin{array}{l} \text{SN54LS222A} \\ \text{16} \times \text{4 SYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY} \\ \text{WITH 3-STATE OUTPUTS} \end{array}$

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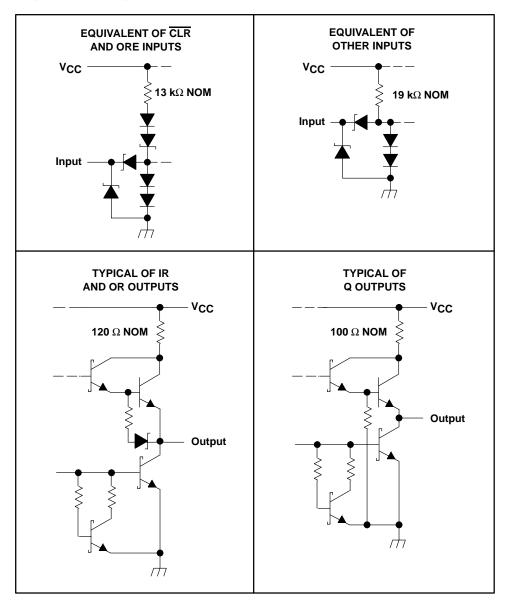




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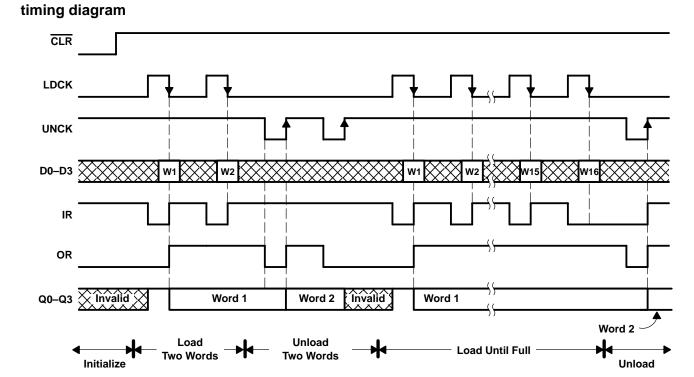
schematics of inputs and outputs





SN54LS222A 16×4 SYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} (see Note 1) –0.5 V	to 7 V
Input voltage range, V ₁	to 7 V
Off-state output voltage range, V _O –0.5 V to) 5.5 V
Storage temperature range, T _{stg}	150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTE 1: All voltage volume are with respect to GND.

NOTE 1: All voltage values are with respect to GND.

recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2			V
VIL	Low-level input voltage				0.7	V
1	High-level output current	Q outputs			-1	mA
юн		IR, OR			-0.4	
IOL		Q outputs			12	~ 1
	Low-level output current IR, OR				4	mA
ТА	T _A Operating free-air temperature				125	°C

NOTE 2: To ensure proper operation of this high-speed FIFO device, it is necessary to provide a clean signal to the LDCK and UNCK clock inputs. Any excessive noise or glitching on the clock inputs that violates the V_{IL}, V_{IH}, or minimum pulse-duration limits can cause a false clock or improper operation of the internal read and write pointers.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	Т	TEST CONDITIONS [†]		TYP‡	MAX	UNIT	
VIK		$V_{CC} = MIN,$	I _I = -18 mA			-1.5	V	
Varia	Q outputs	V _{CC} = MIN,	$I_{OH} = -1 \text{ mA}$	2.4	3.3		V	
VOH	IR, OR	$V_{CC} = MIN,$	I _{OH} = -0.4 mA	2.5	3.4		v	
	Q outputs	$V_{CC} = MIN,$	I _{OL} = 12 mA		0.25	0.4		
VOL	IR, OR	V _{CC} = MIN,	I _{OL} = 4 mA		0.25	0.4	V	
IOZH	Q outputs	V _{CC} = MAX,	V _O = 2.7 V			20	μA	
IOZL	Q outputs	V _{CC} = MAX,	$V_{O} = 0.4 V$			-20	μA	
Ц		V _{CC} = MAX,	V _I = 7 V			0.1	mA	
Ιн		V _{CC} = MAX,	V _I = 2.7 V			20	μA	
۱ _{۱L}		V _{CC} = MAX,	V _I = 0.4 V			-0.4	mA	
	Q outputs			-30		-130	~^^	
IOS§	IR, OR	V _{CC} = MAX		-20		-100	mA	
			Outputs high		84	135		
ICC		$V_{CC} = MAX$	Outputs low		87	155	mA	
			Outputs disabled		89	155		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

§ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

timing requirements over recommended operating conditions (see Note 2 and Figure 2)

			MIN	MAX	UNIT
		LDCK high	60		
t _w		LDCK low	15		
	Pulse duration	UNCK low	30		ns
		UNCK high	30		
		CLR low	20		
		Data to LDCK↓	50		
t _{su}	Setup time	LDCK \downarrow before UNCK \downarrow	50		ns
		UNCK [↑] before LDCK [↑]	50		
t _h	Hold time	Data from LDCK \downarrow	10		ns

NOTE 2: To ensure proper operation of this high-speed FIFO device, it is necessary to provide a clean signal to the LDCK and UNCK clock inputs. Any excessive noise or glitching on the clock inputs that violates the VIL, VIH, or minimum pulse-duration limits can cause a false clock or improper operation of the internal read and write pointers.



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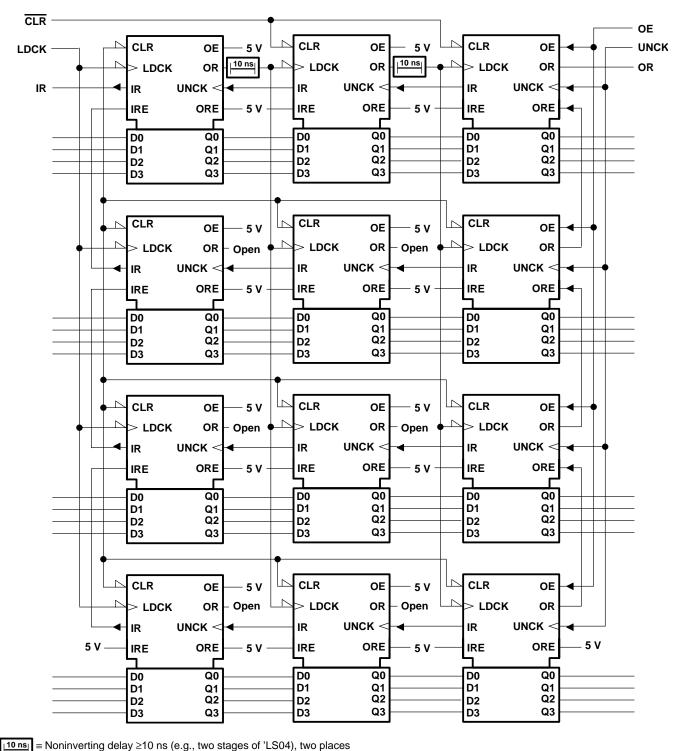
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

_	÷ 00							
PARAMETER	FROM (INPUT)	TO (OUTPUT)		TEST CONDITIONS		TYP	МАХ	UNIT
^t PLH	IRE↑	IR	$P_{1} = 2kO$	C _L = 15 pF		23	35	ns
^t PHL	IRE↓	IX	$K_{L} = 2 K_{2}$	0L = 13 pr		9	15	115
^t PLH	ORE↑	OR	$R_1 = 2 k\Omega$,	$C_{1} = 15 \text{ pc}$		22	35	ns
^t PHL	ORE↓	ÖK	κ <u></u> = 2 κ ₂₂ ,	0L = 13 pr		9	15	115
^t PLH	LDCK↓	IR	$P_{1} = 2k0$	C _L = 15 pF		25	40	ns
^t PHL	LDCK↑		κ <u>Γ</u> = 2 κ ₂₂ ,	0L = 13 pr		36	50	115
^t PLH	LDCK↓	OR	$R_L = 2 k\Omega$,	C _L = 15 pF		48	70	ns
^t PLH	UNCK↑	OR	$P_{1} = 2kO$	CL = 15 pF		29	45	ns
^t PHL	UNCK↓		$K_{L} = 2 K_{2}$	CL = 15 pF		28	45	115
^t PLH	UNCK↑	IR	$R_L = 2 k\Omega$,	CL = 15 pF		49	70	ns
^t PLH		IR	$P_{1} = 2kO$	$C_{1} = 15 \text{ pc}$		36	55	ns
^t PHL	CLR↓	OR	$R_{L} = 2 \ k\Omega,$	CL = 15 pF		25	40	115
tPHL	LDCK↓	Q	RL = 667 Ω,	C _L = 45 pF		34	50	ns
^t PLH		Q RI = 66	$P_{1} = 667.0$	C _L = 45 pF		54	80	ns
^t PHL	UNCK↑	Q	$K_{L} = 007 32,$	CL = 45 pF		45	70	115
^t PZL	OE↑	Q	R ₁ = 667 Ω,	$C_1 = 45 \text{ pE}$		22	35	ns
^t PZH		2	$\mathbf{X}_{\mathrm{L}} = 007 \mathbf{\Omega}_{\mathrm{Z}},$	Ο <u>Γ</u> = 40 μΓ		21	35	115
^t PLZ	OE↓		$C_{1} = 5 \text{ pE}$		16	30	200	
^t PHZ		Q	R _L = 667 Ω,	$O_L = 3 \text{ pr}$		18	30	ns



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APPLICATION INFORMATION

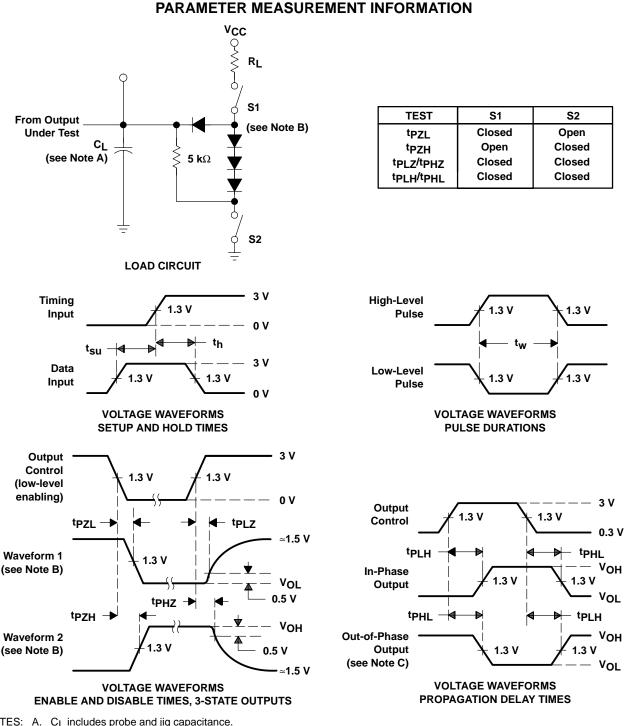
= Noninverting delay ≥10 ns (e.g., two stages of 'LS04), two places



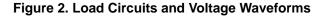


SN54LS222A 16 × 4 SYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY WITH 3-STATE OUTPUTS

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- NOTES: A. C_I includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r < 15 ns, t_f < 6 ns, Z_O \approx 50 Ω .
 - D. All diodes are 1N916 or 1N3064.
 - E. The outputs are measured one at a time with one transition per measurement.





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN54LS222AJ	OBSOLETE	CDIP	J	20	TBD	Call TI	Call TI
SNJ54LS222AJ	OBSOLETE	CDIP	J	20	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN54LS222A :

Catalog: SN74LS222A

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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